Power Rectifier

These state-of-the-art power rectifiers are designed for use in switching power supplies, inverters and as free wheeling diodes.

Features

- Ultrafast 35 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL 94 V-0 @ 0.125 in
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 V
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- These are Pb-Free Devices*

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	600	V
Average Rectified Forward Current (Rated V _R , T _C = 120°C) Total Device	I _{F(AV)}	4.0 8.0	Α
Peak Repetitive Forward Current (Rated V _R , Square Wave, 20 kHz, T _C = 120°C)	I _{FM}	16	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	100	Α
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-65 to +175	°C

THERMAL CHARACTERISTICS (Per Leg)

Rating	Symbol	Value	Unit
Max. Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	3.0	°C/W

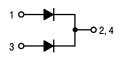
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

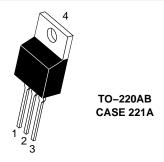


ON Semiconductor®

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ULTRAFAST RECTIFIER8.0 AMPERES, 600 VOLTS





MARKING DIAGRAM



A = Assembly Location

Y = Year
WW = Work Week
UH860 = Device Code
G = Pb-Free Package
AKA = Diode Polarity

ORDERING INFORMATION

Device	Package	Shipping
MURH860CTG	TO-220 (Pb-Free)	50 Units/Rail

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS (Per Leg)

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 1) $ \begin{aligned} &(i_F=4.0 \text{ A, T}_C=150^{\circ}\text{C}) \\ &(i_F=4.0 \text{ A, T}_C=25^{\circ}\text{C}) \end{aligned} $	V _F	2.5 2.8	V
Maximum Instantaneous Reverse Current (Note 1) (Rated DC Voltage, T _C = 150°C) (Rated DC Voltage, T _C = 25°C)	İR	500 10	μΑ
Maximum Reverse Recovery Time $(I_F = 1.0 \text{ A, di/dt} = 50 \text{ A/}\mu\text{s})$	t _{rr}	35	ns

^{1.} Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%

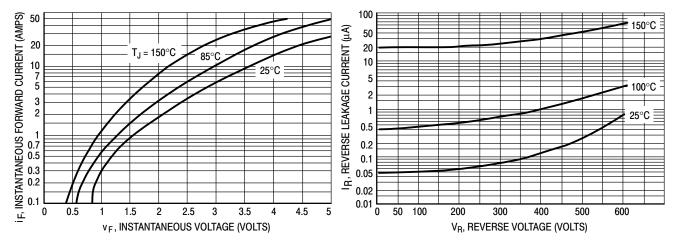


Figure 1. Typical Forward Voltage, Per Leg

Figure 2. Typical Reverse Leakage Current, Per Leg

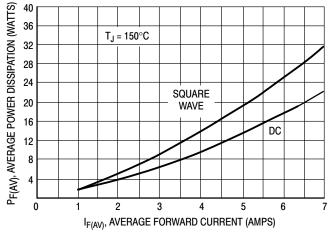


Figure 3. Typical Forward Dissipation, Per Leg

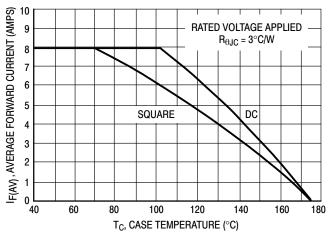


Figure 4. Typical Current Derating, Case, Per Leg

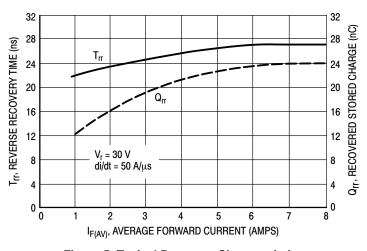


Figure 5. Typical Recovery Characteristics

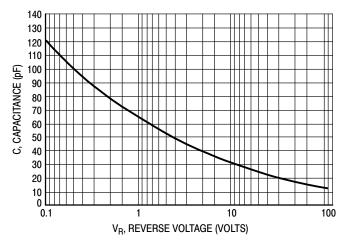
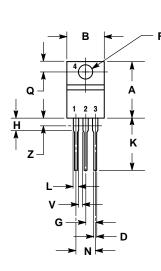
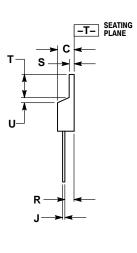


Figure 6. Typical Capacitance, Per Leg

PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH**





NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
_	0.014	0.024	0.36	0.61
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

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